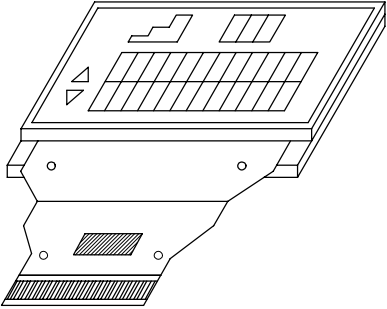
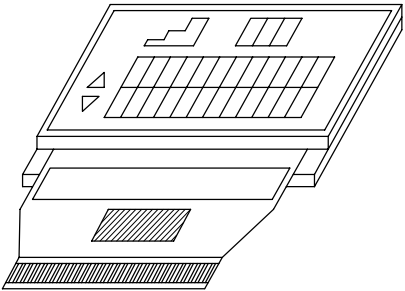
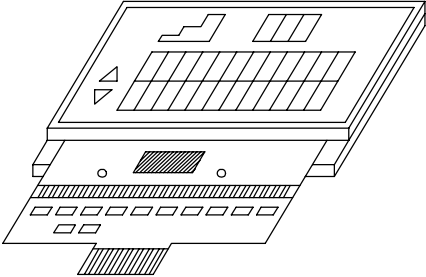
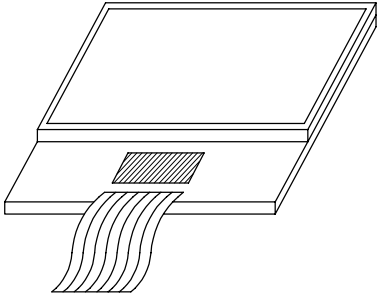
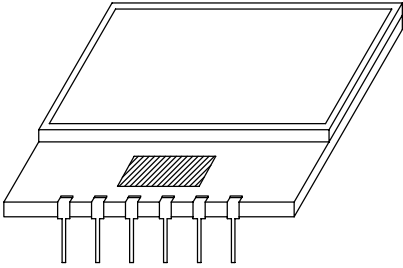
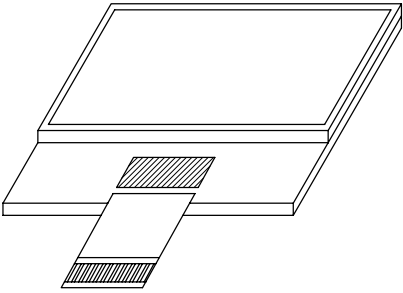


## Assembly Method and module type selection

For connection to the panel terminal portion, either a TAB or a heat seal can be used, and as a method for assembling the controller driver, either a TAB or a COG can be used; and by combining one or the other of these the various types of assembly shown below can be selected. Select the proper type for your application.

Method	TCP + Heatseal	TCP directly
Configuration		
Features	<ul style="list-style-type: none"> <li>• Can often be done without affecting the custom TCP.</li> </ul>	<ul style="list-style-type: none"> <li>• Possible to save space.</li> </ul>
Method	TCP + FPC	COG + Heatseal
Configuration		
Features	<ul style="list-style-type: none"> <li>• Possible to mount chip components on the FPC.</li> </ul>	<ul style="list-style-type: none"> <li>• Thinner than TCP module.</li> </ul>
Method	COG + PIN	COG + FPC
Configuration		
Features	<ul style="list-style-type: none"> <li>• Available soldering</li> </ul>	<ul style="list-style-type: none"> <li>• Thinner than TCP module.</li> </ul>